**WNSC6D08650T** 

Silicon Carbide Diode

#### Rev.01 - 06 December 2022

**Product data sheet** 

### **1. General description**

Silicon Carbide Schottky diode in a DFN 8\*8 plastic package, designed for high frequency switched-mode power supplies.

### 2. Features and benefits

- New 6th Generation Technology
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- High Forward Surge Capability I<sub>FSM</sub>
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

### 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

# 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage				650		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>c</sub> ≤ 160 °C; Fig. 1; Fig. 2; Fig. 3		8		А	
T <sub>j</sub>	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min Typ Max		Unit	
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 8 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.26	1.40	V
		I <sub>F</sub> = 8 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.35	1.55	V
Dynamic	characteristics		1			1	
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 8 A; dI <sub>F</sub> /dt = 500 A/μs; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		-	18	-	nC





# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected	[]	к <del>. К.</del> А
2	n.c.	not connected	5	001aaa020
3	A	anode		
4	А	anode		
5	К	mounting base; connected to cathode	1 2 3 4	

# 6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC6D08650T	DFN8*8	WNSC6D08650T6J	Таре	3000	DFN8X8N	25-Dec-2019		

### 7. Marking

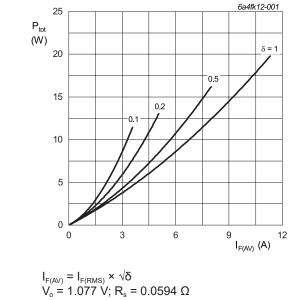
Table 4. Marking codes						
Type number	Marking codes					
WNSC6D08650T	WNSC6D					
	08650T					

# 8. Limiting values

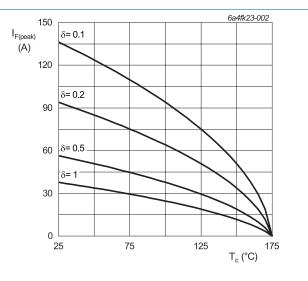
#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{\text{RRM}}$	repetitive peak reverse voltage			650	V
$V_{\text{RWM}}$	crest working reverse voltage			650	V
V <sub>R</sub>	reverse voltage	DC		650	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>c</sub> ≤ 160 °C; Fig. 1; Fig. 2; Fig. 3		8	A
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; t <sub>p</sub> = 25 µs; T <sub>c</sub> ≤ 160 °C; square-wave pulse		16	A
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		56	А
	forward current	$t_p = 10 \ \mu s; T_{j(init)} = 25 \ ^{\circ}C; square-wave pulse$		640	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms		15.68	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-55 to 175	°C
T <sub>j</sub>	junction temperature			-55 to 175	°C

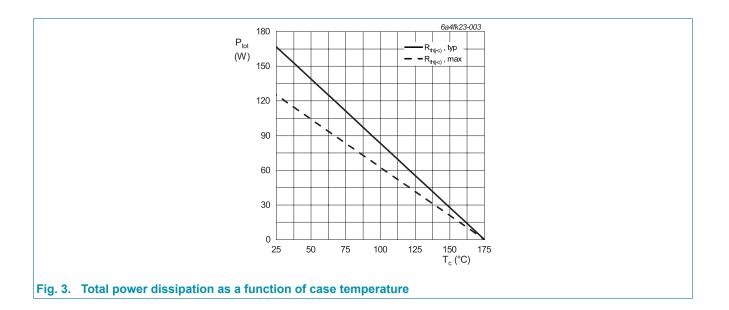


I<sub>F(AV)</sub> = I<sub>F(RMS)</sub> × √δ
V<sub>o</sub> = 1.077 V; R<sub>s</sub> = 0.0594 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



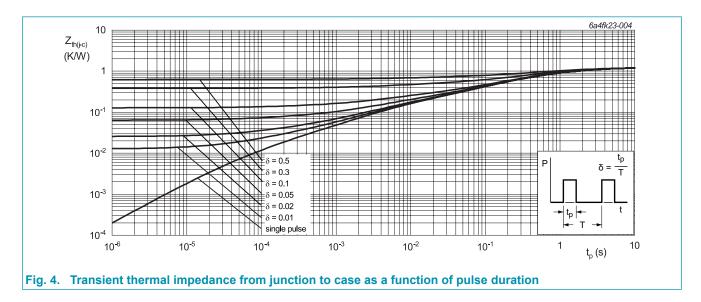


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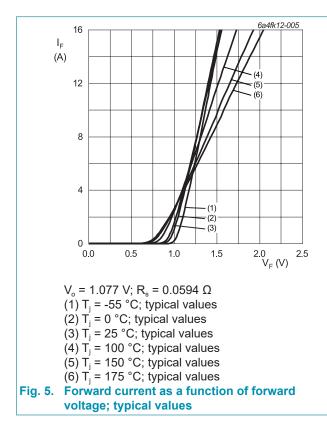
# 9. Thermal characteristics

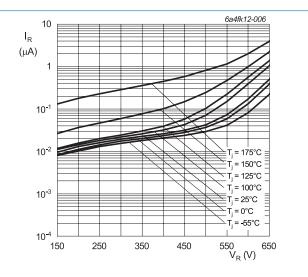
Table 6. Th	ermal characteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case	Fig. 4		-	0.9	1.2	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W



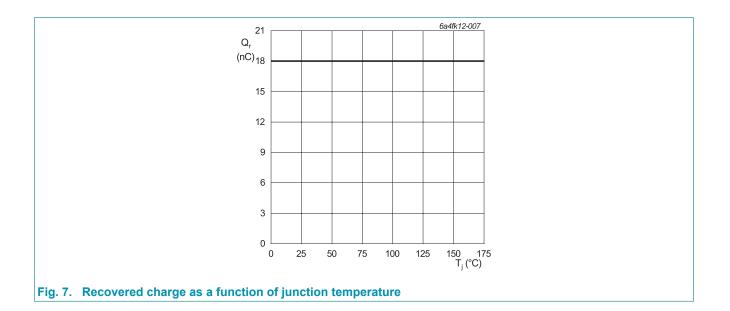
# **10. Characteristics**

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
V <sub>F</sub>	forward current	I <sub>F</sub> = 8 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.26	1.40	V
		I <sub>F</sub> = 8 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.35	1.55	V
		I <sub>F</sub> = 8 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	1.40	1.60	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 650 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	0.8	40	μA
		V <sub>R</sub> = 650 V; T <sub>j</sub> = 175 °C; <u>Fig. 6</u>		-	12	160	μA
Dynamic	characteristics			,			-
Q <sub>r</sub>	recovered charge	$I_F = 8 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{dt} = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	18	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C		-	420	-	pF
		f = 1 MHz; V <sub>R</sub> = 300 V; T <sub>j</sub> = 25 °C		-	45	-	pF
		f = 1 MHz; V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C		-	42	-	pF
E <sub>as</sub>	non-repetitive avalanche energy	I <sub>R</sub> = 4.5 A; L = 5 mH; T <sub>j(init)</sub> = 25 °C		50	-	-	mJ

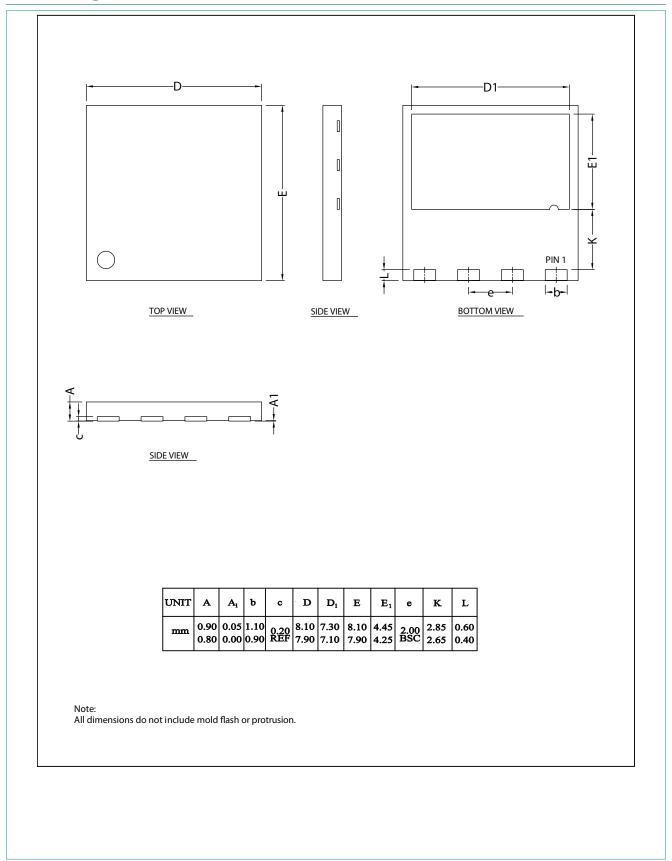








# 11. Package outline



#### WNSC6D08650T Silicon Carbide Diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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